

DATA SHEET

AUTOMOTIVE GRADE HIGH VOLTAGE CHIP RESISTORS

HV series 0.5%, 1%, 5% Sizes 2010/2512

RoHS compliant



YAGEO





Chip Resistor Surface Mount

HV SERIES

2010/2512 (RoHS Compliant)

SCOPE

This specification describes HV2010/2512 high voltage chip resistors with lead-free terminations made by thick film process.

<u>APPLICATIONS</u>

- Automotive
- Converter
- Inverter
- Outdoor Equipments
- Photovoltaic industry
- Power supply

FEATURES

- AEC-Q200 Qualified
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Non-forbidden materials used in products/production
- Halogen Free Epoxy
- Moisture sensitivity level: MSL I
- GB 4943.1-2022 safety certificate issued by CQC
 - * Please refer to CQC certification

ORDERING INFORMATION - GLOBAL PART NUMBER

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

HV XXXX X X X XX XXXX L

(2) (3) (4) (5)

(I) SIZE

2010/2512

(2) TOLERANCE

 $D = \pm 0.5\%$

 $F = \pm 1\%$

 $J = \pm 5\%$

(3) PACKAGING TYPE

R = Paper/PE taping reel

K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

(5) TAPING REEL

07= 7 inch dia. Reel

(6) RESISTANCE VALUE

There are 2~4 digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) DEFAULT CODE

Letter L is system default code for ordering only $^{(Note)}$

Resistance rule of global part number

Resistance code ru	le Example
XXKX	10K = 10,000 Ω
(10 to 97.6 K Ω)	97K6 = 97,600 Ω
XXXK	$100K = 10,000\Omega$
(100 to 976 K Ω)	$976K = 976,000\Omega$
XMXX	$IM = 1,000,000 \Omega$
(I to 9.76 MΩ)	$9M76 = 9,760,000 \Omega$
XXMX	$10M = 10,000,000 \Omega$
(10 to 16 MΩ)	$27M = 27,000,000 \Omega$

ORDERING EXAMPLE

The ordering code of a HV2512 chip resistor, value I $M\Omega$ with ±5% tolerance, supplied in 7-inch tape reel is: HV2512JK-071ML.

NOTE

- I. All our R-Chip products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER



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MARKING

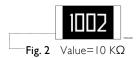
HV 2010/2512



E-24 series: 3 digits, \pm 5%

First two digits for significant figure and 3rd digit for number of zeros

HV2010/2512



Both E-24 and E-96 series: 4 digits, $\pm 0.5\%$ & $\pm 1\%$

First three digits for significant figure and 4th digit for number of zeros

For further marking information, please refer to data sheet "Chip resistors marking".

CONSTRUCTION

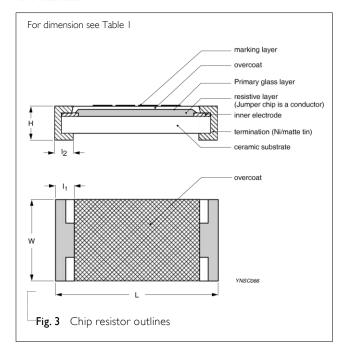
The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal imbedded into a glass and covered by a second glass to prevent environment influences. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the two external terminations (matte tin on Nibarrier) are added. See fig.3

DIMENSIONS

Table I For outlines see fig. 3

TYPE	L (mm)	W (mm)	H (mm)	I _I (mm)	I ₂ (mm)
HV2010	5.00±0.10	2.50±0.15	0.55±0.10	0.55±0.15	0.55±0.20
HV2512	6.35 ±0.10	3.10 ±0.15	0.55 ±0.10	0.60 ±0.20	0.60±0.20

OUTLINES







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ELECTRICAL CHARACTERISTICS

Table 2

TYPE	RESISTANCE RANGE	Rated Power	Temperature	Max. Working		Dielectric Withstanding	Coefficient
HV2010	5% (E-24) 47Ω to 22MΩ 1% (E-24/E-96) 47Ω to 22MΩ	3/4W	_55 °C to +155 °C _	Voltage 2,000 V	Voltage 3,000 V	Voltage 3,000 V	of Resistance 47Ω≤R≤10MΩ
HV2512	0.5% (E-24/E-96) 47 Ω to 10M Ω 5% (E-24) 47 Ω to 16M Ω 1% (E-24/E-96) 47 Ω to 16M Ω 0.5% (E-24/E-96) 47 Ω to 10M Ω	IW		3,000 V	4,000 V	4,000 V	±100ppm°C 10MΩ <r≤22mω ±200ppm°C</r≤22mω

FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	HV2010	HV2512
Paper/PE taping reel (R)	7" (178 mm)		
Embossed taping reel (K)	7" (178 mm)	4,000	4,000

NOTE

1. For Paper/PE/Embossed tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

MLB206 1

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FUNCTIONAL DESCRIPTION

OPERATING TEMPERATURE RANGE

Range: -55 °C to +155 °C

POWER RATING

Each type rated power at 70 °C: HV2010=3/4W; HV2512=1W

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

$$V = \sqrt{(P \times R)}$$

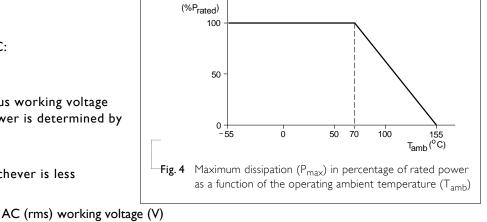
or max. working voltage whichever is less

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$



Ρ

Maximum working voltage can be applicable to resistors only if the resistance value is equal to or higher than the critical resistance value.



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TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
High Temperature Exposure	AEC-Q200 Test 3 MIL-STD-202 Method 108	1,000 hours at T_A = 155 °C, unpowered	$\pm (1.0\% + 0.05\Omega)$ for D/F tol $\pm (2.0\% + 0.05\Omega)$ for J tol <50 m Ω for Jumper
Moisture Resistance	MIL-STD-202 Method 106	Each temperature / humidity cycle is defined at 8 hours, 3 cycles / 24 hours for 10d, with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered	$\pm (0.5\% \pm 0.05\Omega)$ for D/F tol $\pm (2.0\% \pm 0.05\Omega)$ for J tol <100 m Ω for Jumper
Biased Humidity	AEC-Q200 Test 7 MIL-STD-202 Method 103	I,000 hours; 85 °C / 85% RH I 0% of operating power Measurement at 24±4 hours after test conclusion.	$\pm (3.0\% + 0.05\Omega)$ <100 m Ω for Jumper
Operational Life	AEC-Q200 Test 8 MIL-STD-202 Method 108	1,000 hours at 125 °C, derated voltage applied for 1.5 hours on, 0.5 hour off, still-air required	$\pm (1.0\% + 0.05\Omega)$ for D/F tol $\pm (3.0\% + 0.05\Omega)$ for J tol <100 m Ω for Jumper
Resistance to Soldering Heat	AEC-Q200 Test 15 MIL-STD-202 Method 210	Condition B, no pre-heat of samples Lead-free solder, 260±5 °C, 10±1 seconds immersion time Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	$\pm (0.5\% \pm 0.05\Omega)$ for D/F tol $\pm (1.0\% \pm 0.05\Omega)$ for J tol <50 m Ω for Jumper No visible damage
Thermal Shock	MIL-STD-202 Method 107	-55/+125 °C Number of cycles is 300. Devices mounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air — Air	$\pm (0.5\% + 0.05\Omega)$ for D/F tol $\pm (1.0\% + 0.05\Omega)$ for J tol <50 m Ω for Jumper
ESD	AEC-Q200 Test 17 AEC-Q200-002	Human Body Model, I pos. + I neg. discharges 0201:500V 0402/0603: IKV 0805 and above: 2KV	$\pm (3.0\% \pm 0.05\Omega)$ <50 m Ω for Jumper





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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability - Wetting	AEC-Q200 Test 18 J-STD-002	Electrical Test not required Magnification 50X SMD conditions: (a) Method B, aging 4 hours at 155 °C dry heat, dipping at 235±3 °C for 5±0.5 seconds. (b) Method B, steam aging 8 hours, dipping at 215±3 °C for 5±0.5 seconds. (c) Method D, steam aging 8 hours, dipping at 260±3 °C for 30±0.5 seconds.	Well tinned (≥95% covered) No visible damage
Board Flex	AEC-Q200 Test 21 AEC-Q200-005	Chips mounted on a 100mm × 40mm glass epoxy resin PCB (FR4) Bending for 0201/0402: 5 mm 0603/0805: 3 mm 1206 and above: 2 mm Holding time: minimum 60 seconds	\pm (1.0%+0.05Ω) <50 mΩ for Jumper
Temperature Coefficient of Resistance (T.C.R.)	MIL-STD-202 Method 304	At +25/–55 °C and +25/+125 °C Refer to table 2 Formula: $T.C.R = \frac{R_2 - R_1}{R_1(t_2 - t_1)} \times 10^6 \text{ (ppm/°C)}$ Where $t_1 = +25 \text{ °C or specified room temperature}$ $t_2 = -55 \text{ °C or } +125 \text{ °C test temperature}$ $R_1 = \text{resistance at reference temperature in ohms}$ $R_2 = \text{resistance at test temperature in ohms}$	
Short Time Overload	IEC60115-1 8.1	2.5 times of rated voltage or maximum overload voltage whichever is less for 5 sec at room temperature	$\pm (1.0\% + 0.05\Omega)$ for D/F tol $\pm (2.0\% + 0.05\Omega)$ for J tol <50 m Ω for Jumper





Product specification



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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version I	Sep. 5, 2023	-	- Add GB 4943.1-2022 safety certificate declaration
Version 0	Aug. 19, 2021	-	- First issue



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